

# GP2Y0A41SK0F

Distance Measuring Sensor Unit  
Measuring distance : 4 to 30 cm  
Analog output type



## ■Description

**GP2Y0A41SK0F** is a distance measuring sensor unit, composed of an integrated combination of PSD (position sensitive detector) , IR-LED (infrared emitting diode) and signal processing circuit. The variety of the reflectivity of the object, the environmental temperature and the operating duration are not influenced easily to the distance detection because of adopting the triangulation method. This device outputs the voltage corresponding to the detection distance. So this sensor can also be used as a proximity sensor.

## ■Agency approvals/Compliance

1. Compliant with RoHS directive (2002/95/EC)

## ■Applications

1. Cleaning robot
2. Personal robot
3. Sanitary

## ■Features

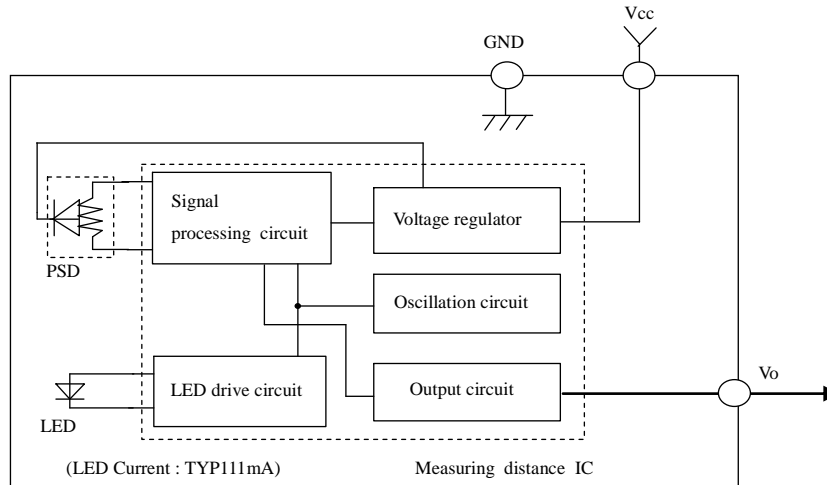
1. Distance measuring sensor is united with PSD, infrared LED and signal processing circuit
2. Short measuring cycle (16.5ms)
3. Distance measuring range : 4 to 30 cm
4. Package size (29.5 × 13.0 × 13.5mm)
5. Analog output type

Notice The content of data sheet is subject to change without prior notice.

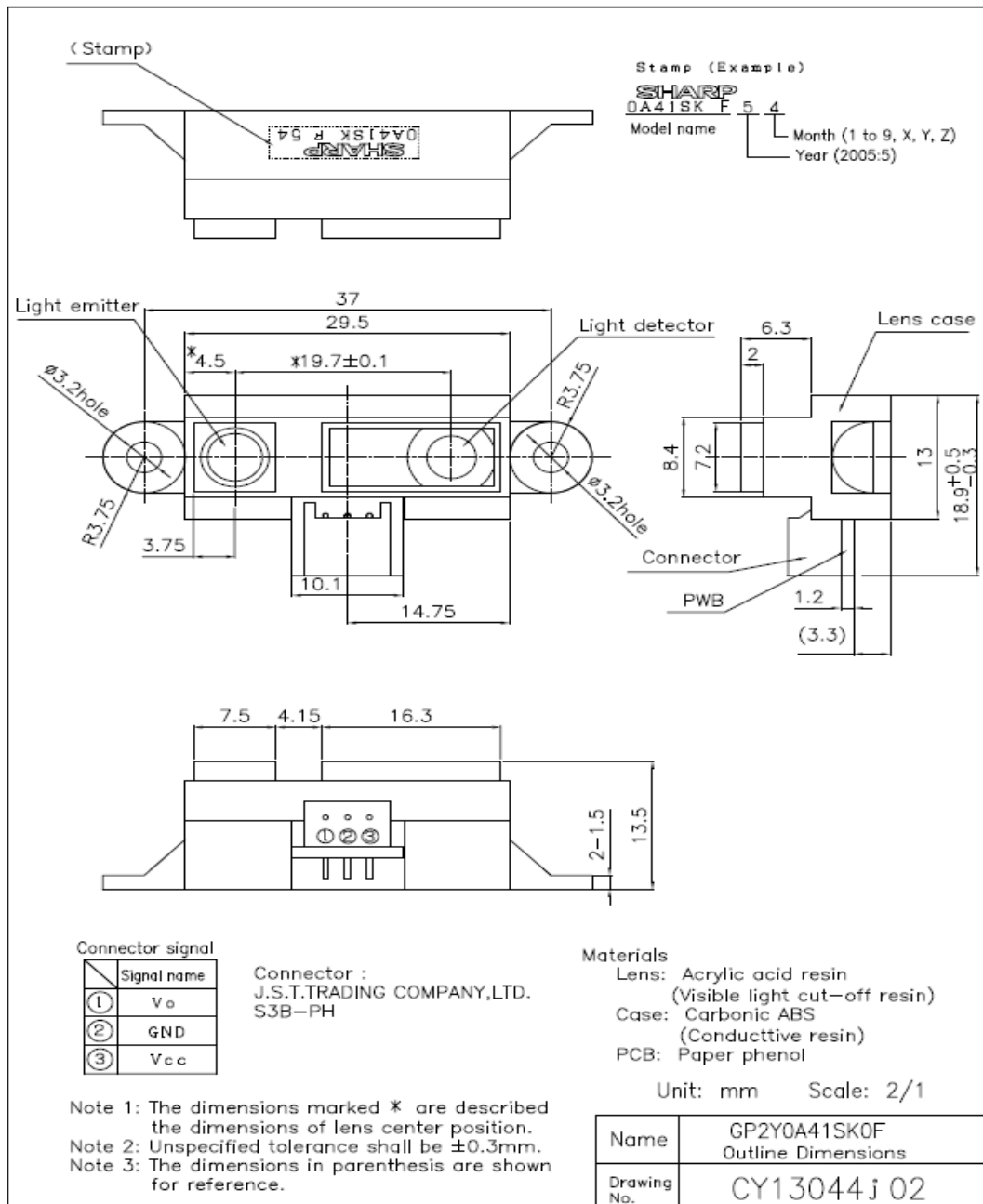
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Sheet No.: OP13008EN

## ■Schematic



## ■Outline



## ■Absolute maximum ratings

(Ta=25°C, Vcc=5V)

| Parameter               | Symbol | Ratings         | Unit | Remark |
|-------------------------|--------|-----------------|------|--------|
| Supply voltage          | Vcc    | -0.3 to +7      | V    | -      |
| Output terminal voltage | Vo     | -0.3 to Vcc+0.3 | V    | -      |
| Operating temperature   | Topr   | -10 to +60      | °C   | -      |
| Storage temperature     | Tstg   | -40 to +70      | °C   | -      |

## ■Operating supply voltage

| Symbol | Rating     | Unit | Remark |
|--------|------------|------|--------|
| Vcc    | 4.5 to 5.5 | V    | -      |

## ■Electro-optical Characteristics

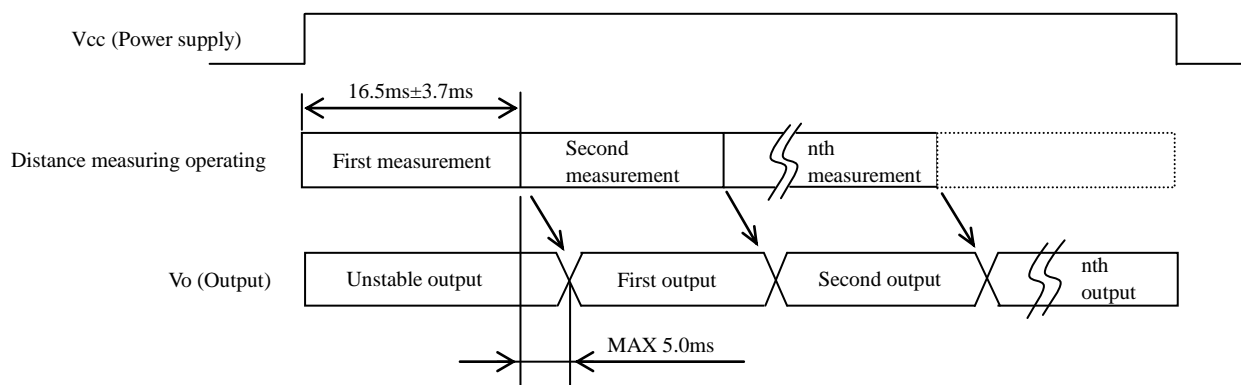
| Parameter                 | Symbol       | Conditions   | MIN. | TYP. | MAX. | Unit |
|---------------------------|--------------|--|------|------|------|------|
| Measuring distance range  | $\Delta L$   | (Note 1)   | 4    | -    | 30   | Cm   |
| Output terminal voltage   | Vo           | L=30cm (Note 1)  | 0.25 | 0.4  | 0.55 | V    |
| Output voltage difference | $\Delta V_o$ | Output change at L change<br>(30cm $\rightarrow$ 4cm) (Note 1) | 1.95 | 2.25 | 2.55 | V    |
| Average supply current    | Icc          | L=30cm (Note 1)  | -    | 12   | 22   | mA   |

※L : Distance to reflective object

(Note 1) Using reflective object : White paper

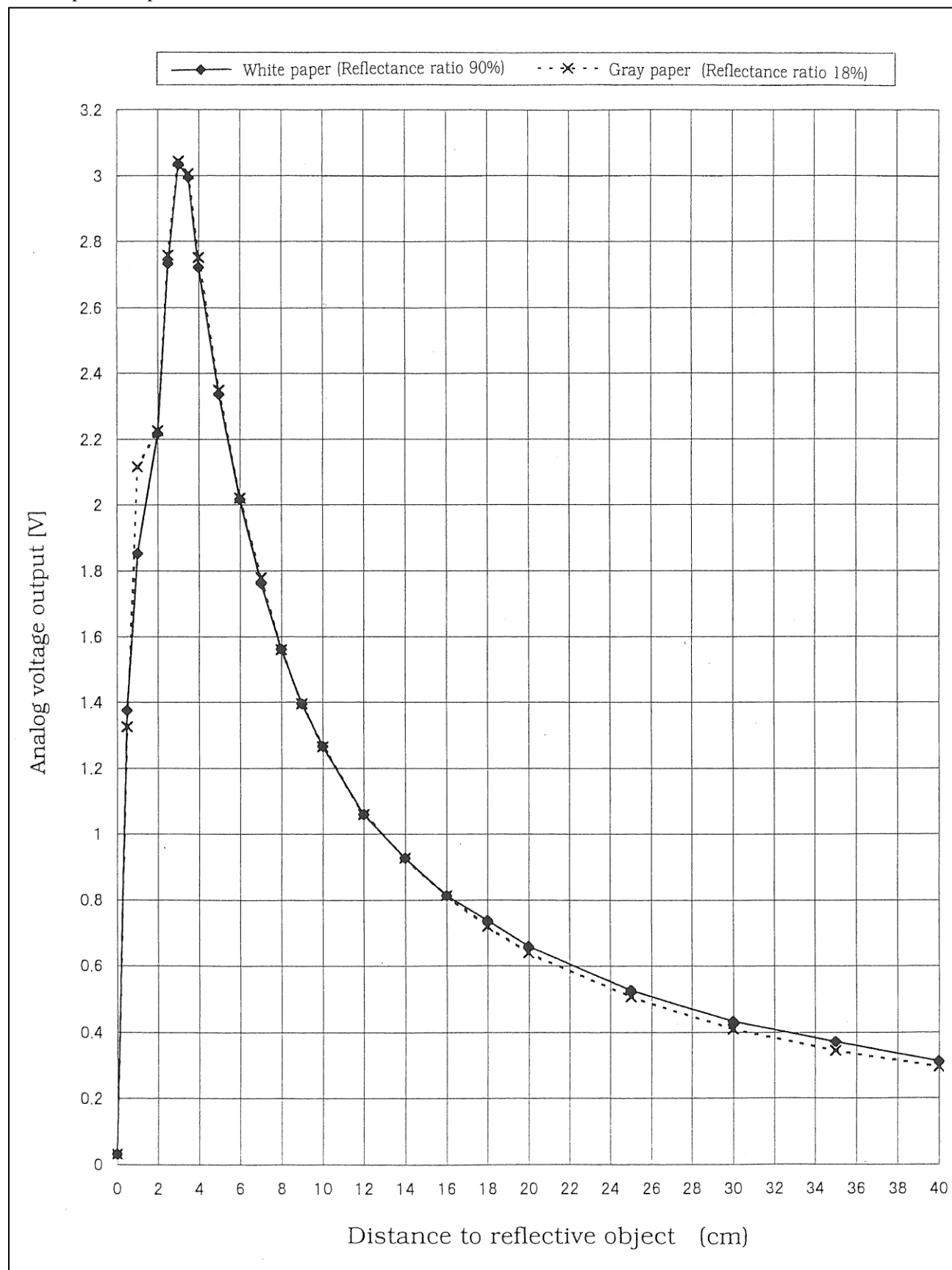
(Made by Kodak Co., Ltd. gray cards R-27 • white face, reflective ratio ; 90%)

## ■Timing Chart

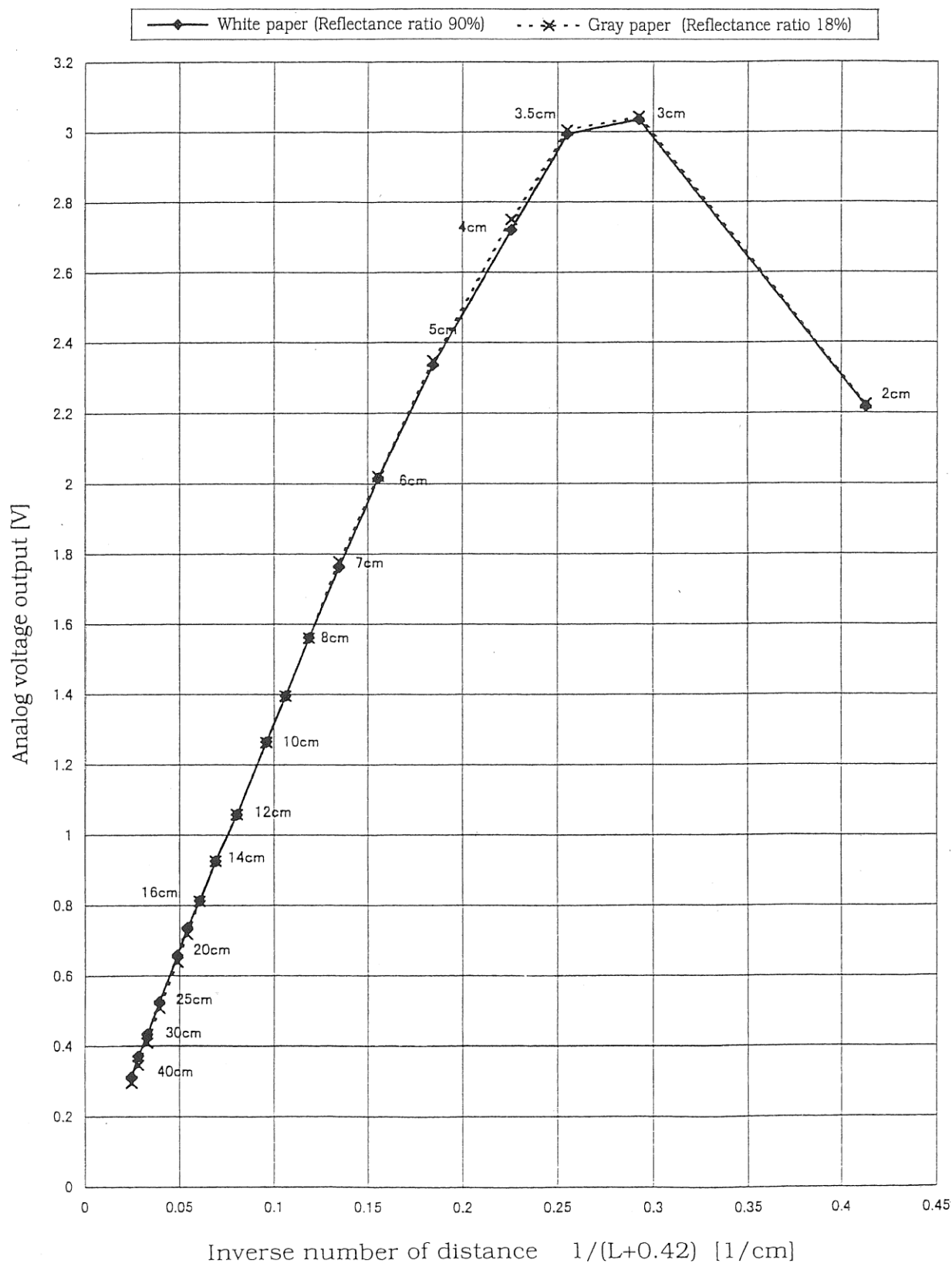


## ■Supplements

- Example of output distance characteristics



●Example of output distance characteristics with the inverse of distance



- This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFCs, Halon, Carbon tetrachloride 1.1.1-Trichloroethane (Methyl chloroform)

- Product mass : Approx. 3.6g (TYP)
- This product does not contain the chemical materials regulated by RoHS directive.  
(Except for the NOT regulated by RoHS directive.)
- Compliance with each regulation

1) The RoHS directive(2002/95/EC)

This product complies with the RoHS directive(2002/95/EC) .

Object substances: mercury, lead (except for lead in high melting temperature type solders<sup>\*1</sup> and glass of electronic components), cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE)

\*1 : i.e. tin-lead solder alloys containing more than 85% lead

2) Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic Information Products Regulation (Chinese : 电子信息产品污染控制管理办法).

| Category                  | Toxic and hazardous substances |              |              |   |                                |                                       |
|---------------------------|--------------------------------|--------------|--------------|---|--------------------------------|---------------------------------------|
|                           | Lead (Pb)                      | Mercury (Hg) | Cadmium (Cd) | Hexavalent chromium (Cr <sup>6+</sup> ) | Polybrominated biphenyls (PBB) | Polybrominated diphenyl ethers (PBDE) |
| Distance Measuring Sensor | *                              | ✓            | ✓            | ✓                                       | ✓                              | ✓                                     |

✓ : indicates that the content of the toxic and hazardous substance in all the homogeneous materials of the part is below the concentration limit requirement as described in SJ/T 11363-2006 standard .

\* : indicates that the content of the toxic and hazardous substance in at least one homogeneous material of the part exceeds the concentration limit requirement as described in SJ/T 11363-2006 standard.

Lead in high melting temperature type solders (i.e. tin-lead solder alloys containing more than 85% lead) and glass of electronic components (designated by “\*” in the above table) are exempt from the RoHS directive (2002/95/EC), because there is no effective way to eliminate or substitute them by present scientific technology.

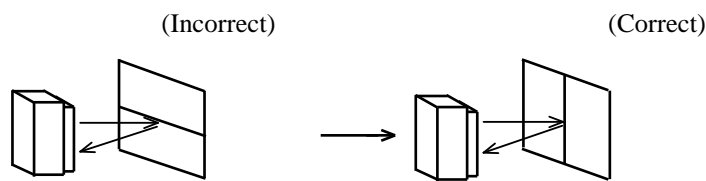
## ■Notes

[Advice for the optics]

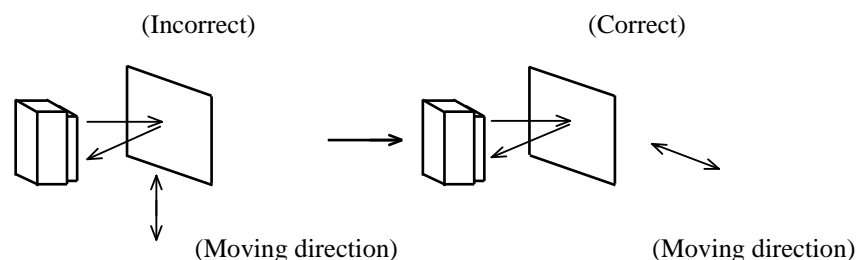
- Lens of this device shall be kept cleanly. There are cases that dust, water or oil and so on deteriorate the characteristics of this device. Please consider in actual application.
- In case that protection is set in front of the emitter and detector portion, the protection cover which has the most efficient transmittance at the emitting wavelength range of LED for this product ( $\lambda=870\text{nm}\pm 70\text{nm}$ ), shall be recommended to use. The face and back of protection cover should be mirror polishing. Also, as there are cases that the characteristics may not be satisfied with according to the distance between the protection cover and this product or the thickness of the protection cover, please use this product after confirming the operation sufficiently in actual application.

[Advice for the characteristics]

- In case that there is an object near to light exits of the sensor between the sensor and the detected object, please use this device after confirming sufficiently what the characteristics of this sensor do not change by the object.
- When the detector surface receive direct light from the sun, tungsten lamp and so on, there are cases that it can not measure the distance exactly. Please consider the design that the detector does not receive direct light from such light source.
- Distance between sensor and mirror reflector can not sometimes measure exactly.  
In case of changing the mounting angle of this product, it may measure the distance exactly.
- In case that reflective object has boundary line clearly, there is cases that distance can not measure exactly.  
At that time, if direction of boundary line and the line between emitter center and detector center parallels, it is possible to decrease deviation of measuring distance.



- In order to decrease measuring error by moving direction of object, we recommend to mount the sensor like below drawing.

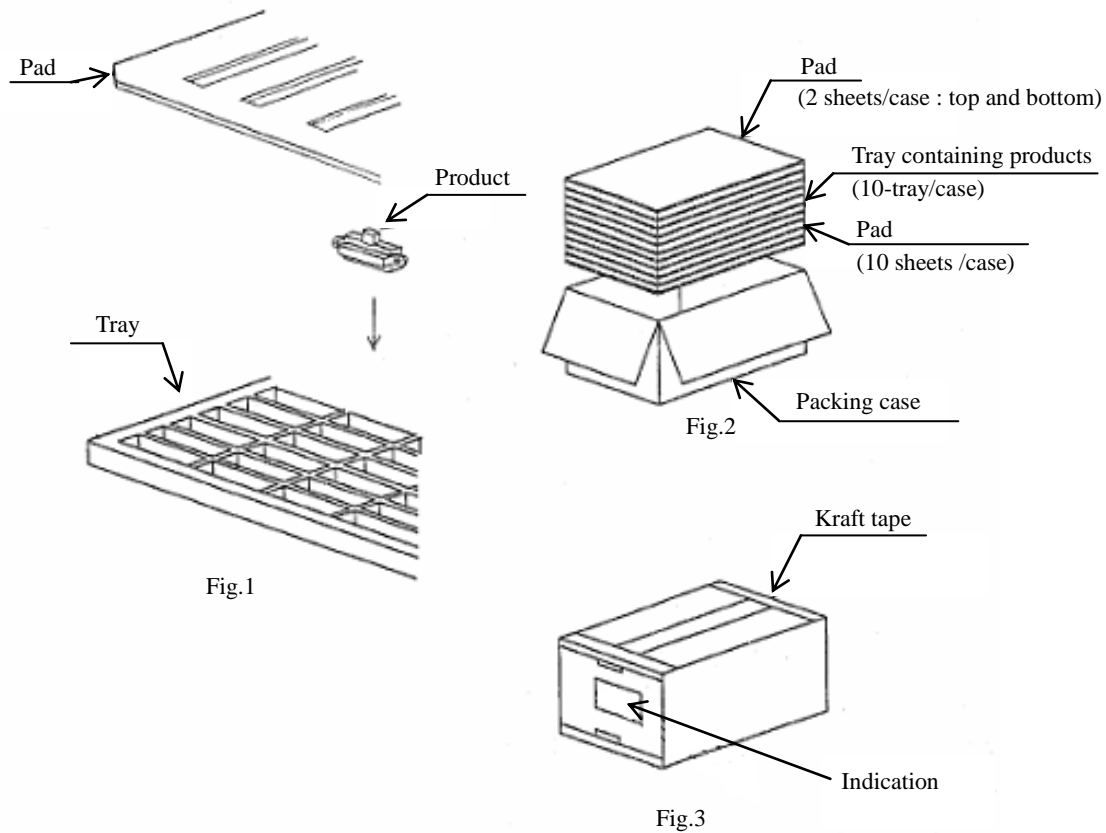


- In order to stabilize power supply line, we recommend to connect a by-pass capacitor of 10 $\mu\text{F}$  or more between Vcc and GND near this product.

[Notes on handling]

- Please don't do washing. Washing may deteriorate the characteristics of optical system and so on.  
Please confirm resistance to chemicals under the actual usage since this product has not been designed against for washing.
- There are some possibilities that the sensor inside the case package with lens may be exposed to the excessive mechanical stress. Please be careful not to cause any excessive pressure on the case package with lens and also on the PCB at the assembly and inserting of the set.

## ■ Packing specification



1. Packing numbers  
 MAX. 100 pieces per tray  
 MAX 1000 pieces per case
2. Arranges in 10 stages of trays containing products into the packing case.  
 Put pads on their top and bottom.  
 Closes the lid of case and seals with kraft tape.
3. Indication items  
 The contents of the carton indication conforms to EIAJ C-3 and the following items are indicated.  
 Model No., Internal production control name, Quantity, Packing date, Corporate name, Country of origin



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- Personal computers
- Office automation equipment
- Telecommunication equipment [terminal]
- Test and measurement equipment
- Industrial control
- Audio visual equipment
- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

with equipment that requires higher reliability such as:

- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).

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